



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

ECH8602M — General-Purpose Switching Device Applications

Features

- 2.5V drive
- Common-drain type
- Protection diode in
- Best suited for LiB charging and discharging switch
- Halogen free compliance

Specifications

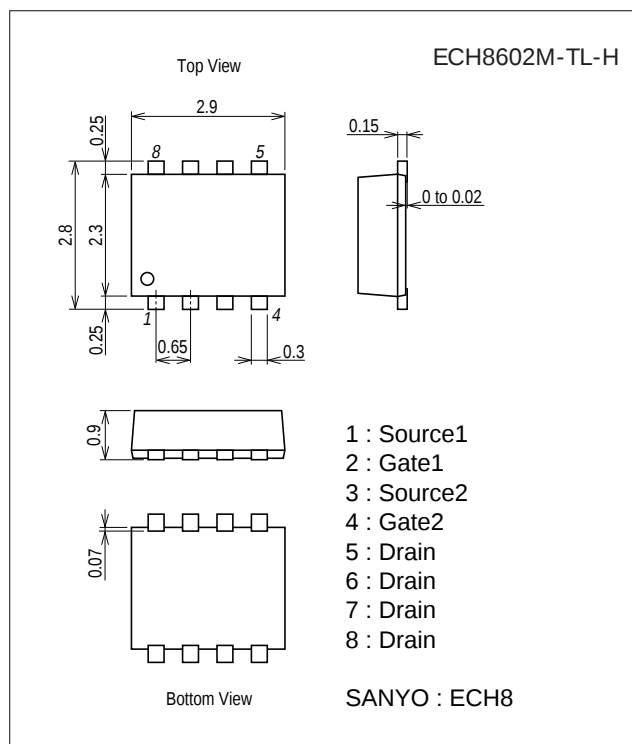
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DS}		30	V
Gate-to-Source Voltage	V_{GS}		± 12	V
Drain Current (DC)	I_D		6	A
Drain Current (Pulse)	I_{DP}	$PW \leq 10\mu s$, duty cycle $\leq 1\%$	60	A
Allowable Power Dissipation	P_D	When mounted on ceramic substrate (900mm ² ×0.8mm) 1unit	1.4	W
Total Dissipation	P_T	When mounted on ceramic substrate (900mm ² ×0.8mm)	1.5	W
Channel Temperature	T_{ch}		150	°C
Storage Temperature	T_{stg}		-55 to +150	°C

Package Dimensions

unit : mm (typ)

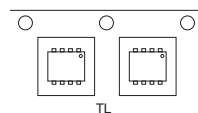
7011A-003



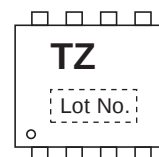
Product & Package Information

- Package : ECH8
- JEITA, JEDEC : -
- Minimum Packing Quantity : 3,000 pcs./reel

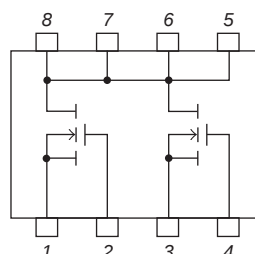
Packing Type : TL



Marking



Electrical Connection

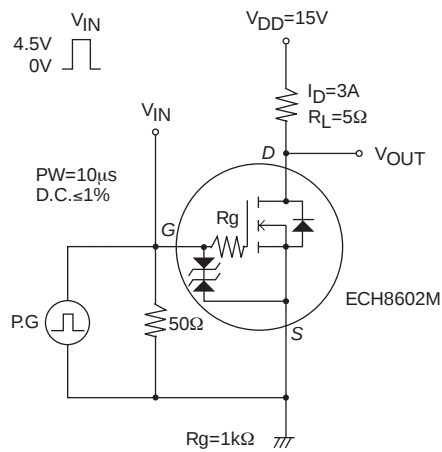


ECH8602M

Electrical Characteristics at Ta=25°C

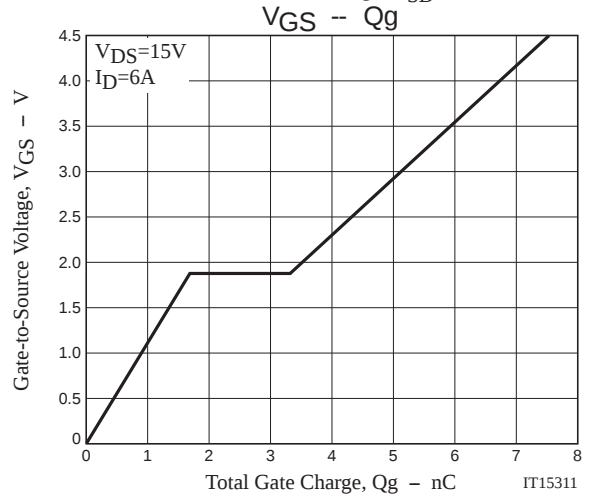
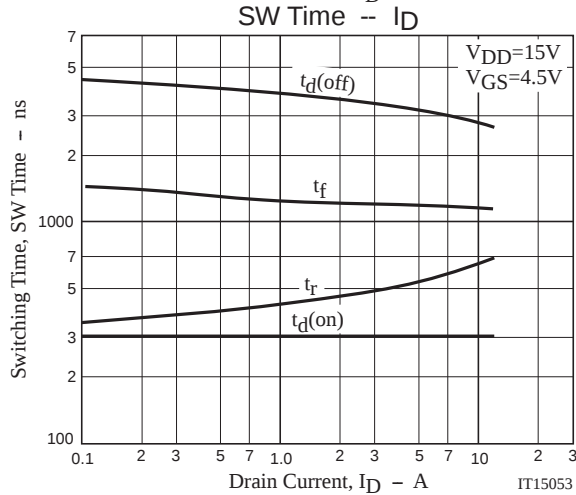
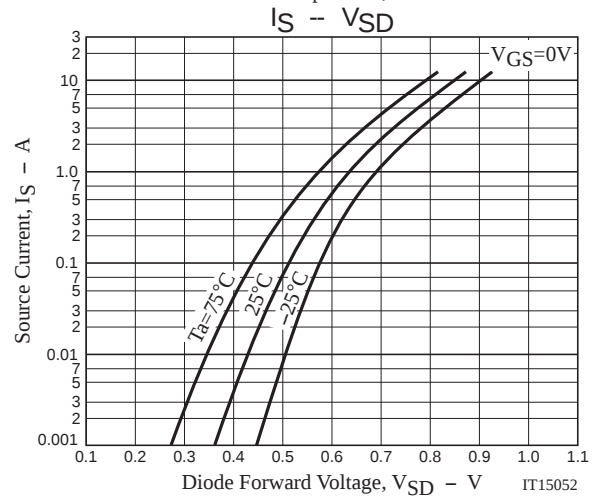
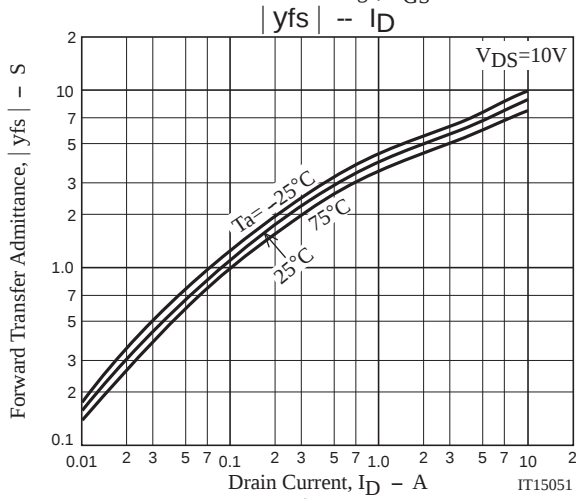
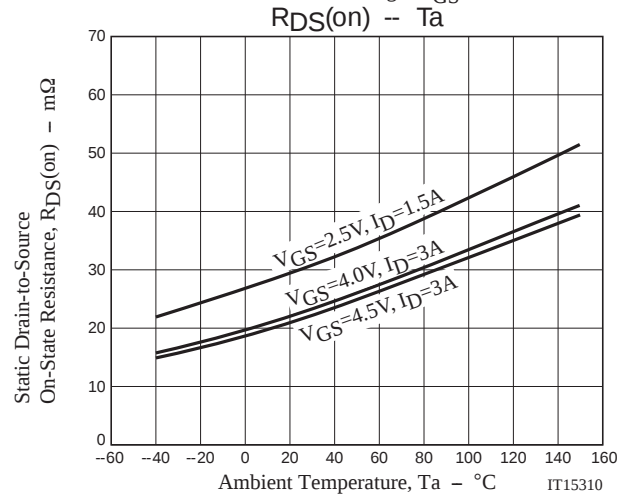
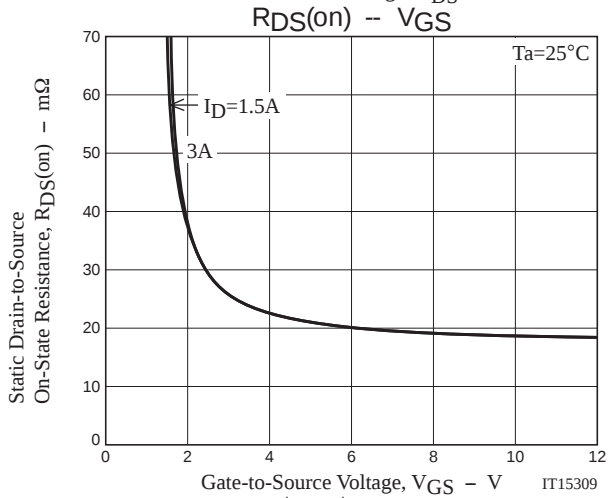
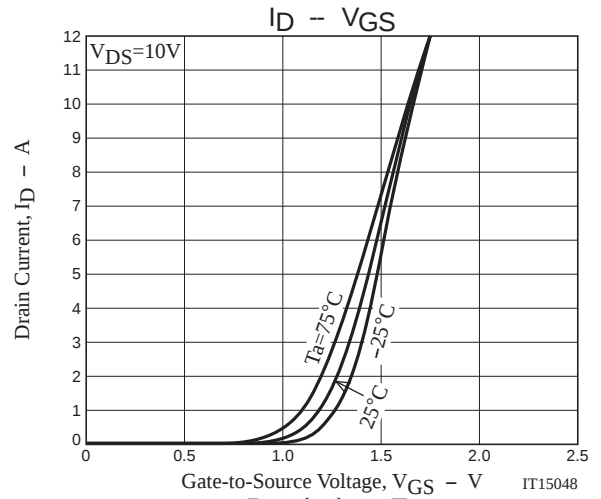
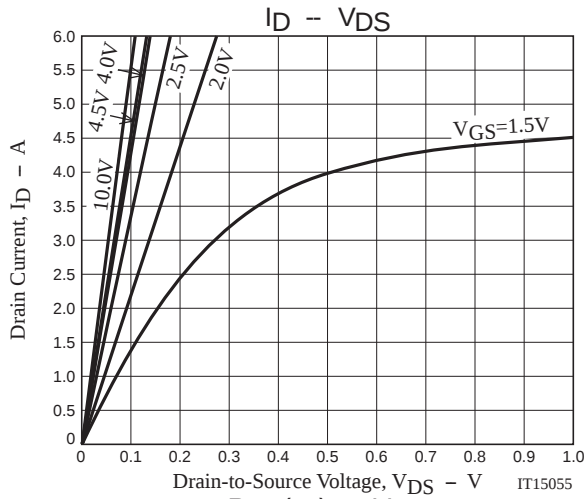
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=1mA, V_{GS}=0V$	30			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30V, V_{GS}=0V$			1	μA
Gate-to-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 8V, V_{DS}=0V$			± 10	μA
Cutoff Voltage	$V_{GS(off)}$	$V_{DS}=10V, I_D=1mA$	0.5		1.3	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS}=10V, I_D=3A$		5		S
Static Drain-to-Source On-State Resistance	$R_{DS(on)1}$	$I_D=3A, V_{GS}=4.5V$	15.4	22	30	$m\Omega$
	$R_{DS(on)2}$	$I_D=3A, V_{GS}=4.0V$	16.1	23	31	$m\Omega$
	$R_{DS(on)3}$	$I_D=1.5A, V_{GS}=2.5V$	18	30	44	$m\Omega$
Turn-ON Delay Time	$t_d(on)$	See specified Test Circuit.		305		ns
Rise Time	t_r			490		ns
Turn-OFF Delay Time	$t_d(off)$			3500		ns
Fall Time	t_f			1200		ns
Total Gate Charge	Q_g	$V_{DS}=15V, V_{GS}=4.5V, I_D=6A$		7.5		nC
Gate-to-Source Charge	Q_{gs}			1.7		nC
Gate-to-Drain "Miller" Charge	Q_{gd}			1.6		nC
Diode Forward Voltage	V_{SD}	$I_S=6A, V_{GS}=0V$		0.8	1.2	V

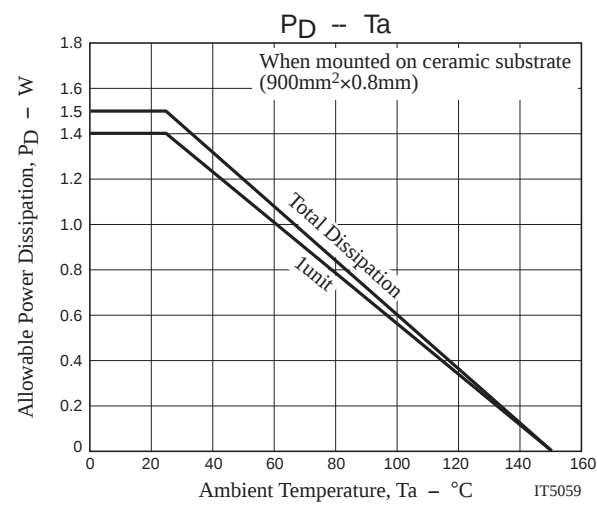
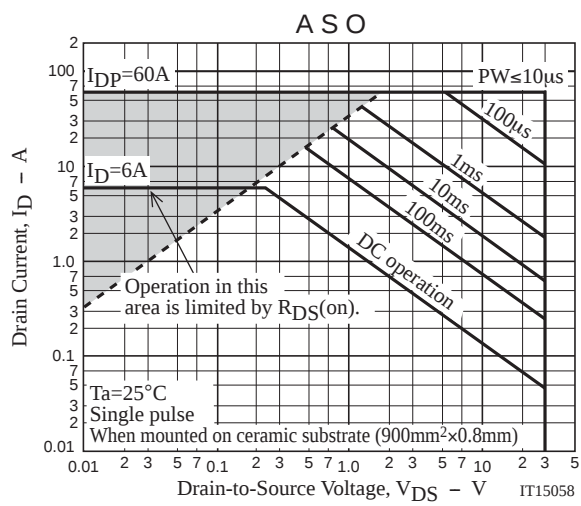
Switching Time Test Circuit



Ordering Information

Device	Package	Shipping	memo
ECH8602M-TL-H	ECH8	3,000pcs./reel	Pb Free and Halogen Free



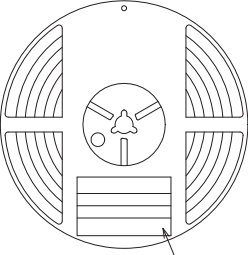


Embossed Taping Specification
ECH8602M-TL-H

1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
ECH8	CPH6	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Packing method



Reel label

Reel label, Inner box label (unit:mm)

69	43	80
(P) TYPE 000000000		
(1) LOT 00		
(Q) QTY 0,000 (1) LEAD FREE *		
(2) SPECIAL		
20722005310C		
ASSEMBLY:**** (DIFFUSION:****)		

Outer box label

It is a label at the time of factory shipments. The form of a label may change in physical distribution process.

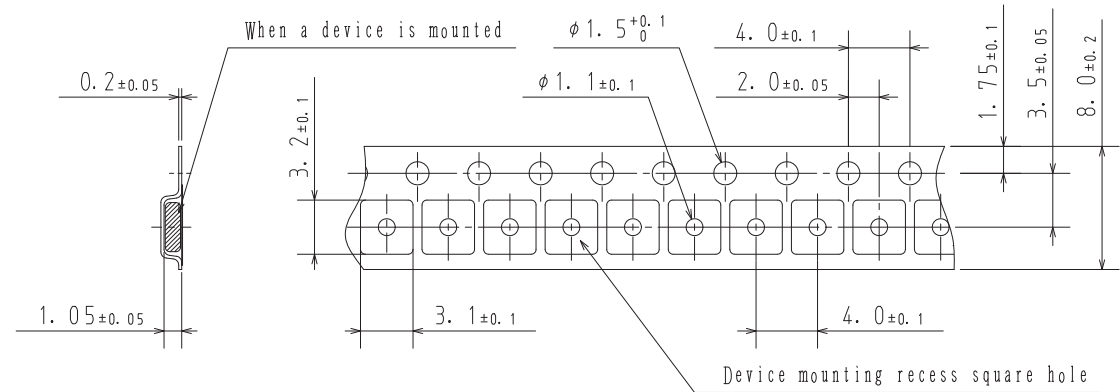
108	43	80
TYPE CODE		
TYPE 000000000		
QTY 0,000 PCS (1) LEAD FREE *		
LOT 000000000		
PACKAGE 000000000		
SPECIAL		
20722005310C		
ASSEMBLY:**** (DIFFUSION:****)		

NOTE (1)
The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

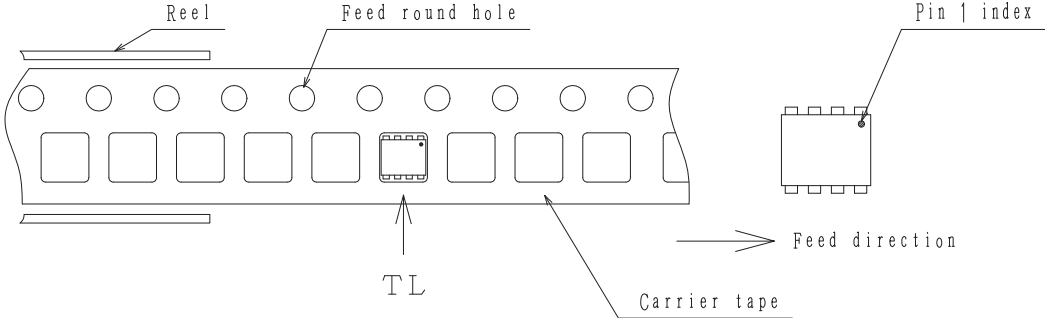
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



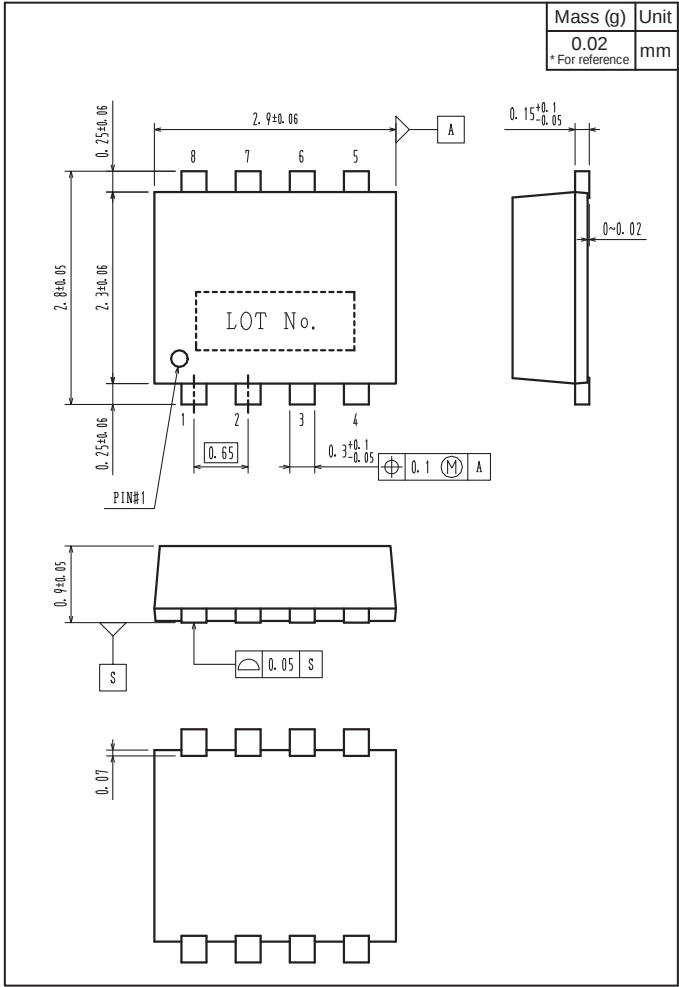
2-2. Device placement direction



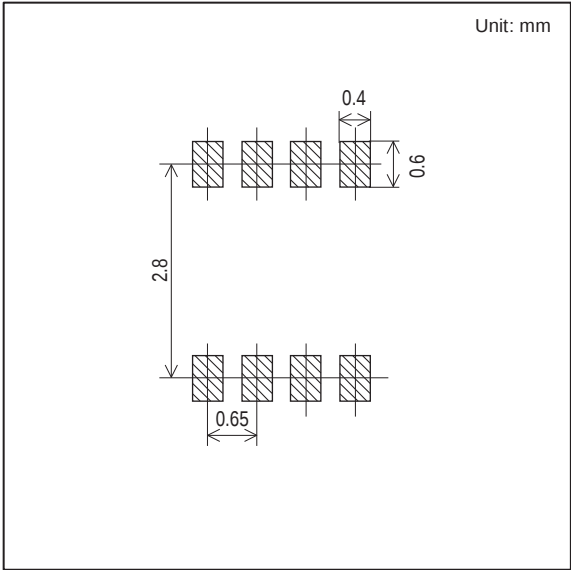
Those with pin 1 index on the feed hole side.....TL

ECH8602M

Outline Drawing
ECH8602M-TL-H



Land Pattern Example



Note on usage : Since the ECH8602M is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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